

Electronic Filing System (EFS) Data
Electronic Patent Application Submission
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EFS ID: 12824
Application ID: 09682934
Title of Invention: METHOD FOR CONTRAST
MATCHING OF MULTIPLE IMAGES OF
THE SAME OBJECT OR SCENE TO A
COMMON REFERENCE IMAGE
First Named Inventor: Gopal Avinash
Domestic/Foreign Application: Domestic Application
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Effective Receipt Date: 2001-11-01
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Attorney Docket Number: 120768
Digital Certificate Holder: cn=Kevin Mierzwa, ou=Registered Attorneys, ou=Patent and Trademark
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Total Fees Authorized: \$780.0
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Deposit Account Name: Kevin G. Mierzwa



TRANSMITTAL FORM

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Stylesheet Version: 1.0

Attorney Docket Number:

120768



METHOD FOR CONTRAST MATCHING OF MULTIPLE IMAGES OF THE SAME OBJECT OR SCENE TO A COMMON REFERENCE IMAGE

First Named Inventor: Gopal B. Avinash

SUBMITTED BY

Name:

Kevin G. Mierzwa

Registration Number:

38049

Electronic Signature Mark: Kevin G.
Mierzwa

Date Signed: 20011101

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Attached Files:

patent-assignment

GEMS0135asgn.xml

specification

specification.xml

declaration

Declaration.tif

declaration

Declaration2.tif

bibd-transmittal

GEMS0135apds.xml

fee-transmittal

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Attached Image File(s):

Declaration.tif

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[illegible]

Comments:

[illegible]

	78	96	114	132	150	168	186	204	222	240	258	276	294	312	330	348	366	384	402	420	438	456	474	492	510	528	546	564	582	600	618	636	654	672	690	708	726	744	762	780	798	816	834	852	870	888	906	924	942	960	978	996	1014	1032	1050	1068	1086	1104	1122	1140	1158	1176	1194	1212	1230	1248	1266	1284	1302	1320	1338	1356	1374	1392	1410	1428	1446	1464	1482	1500	1518	1536	1554	1572	1590	1608	1626	1644	1662	1680	1698	1716	1734	1752	1770	1788	1806	1824	1842	1860	1878	1896	1914	1932	1950	1968	1986	2004	2022	2040	2058	2076	2094	2112	2130	2148	2166	2184	2202	2220	2238	2256	2274	2292	2310	2328	2346	2364	2382	2400	2418	2436	2454	2472	2490	2508	2526	2544	2562	2580	2598	2616	2634	2652	2670	2688	2706	2724	2742	2760	2778	2796	2814	2832	2850	2868	2886	2904	2922	2940	2958	2976	2994	3012	3030	3048	3066	3084	3102	3120	3138	3156	3174	3192	3210	3228	3246	3264	3282	3300	3318	3336	3354	3372	3390	3408	3426	3444	3462	3480	3498	3516	3534	3552	3570	3588	3606	3624	3642	3660	3678	3696	3714	3732	3750	3768	3786	3804	3822	3840	3858	3876	3894	3912	3930	3948	3966	3984	4002	4020	4038	4056	4074	4092	4110	4128	4146	4164	4182	4200	4218	4236	4254	4272	4290	4308	4326	4344	4362	4380	4398	4416	4434	4452	4470	4488	4506	4524	4542	4560	4578	4596	4614	4632	4650	4668	4686	4704	4722	4740	4758	4776	4794	4812	4830	4848	4866	4884	4902	4920	4938	4956	4974	4992	5010	5028	5046	5064	5082	5100	5118	5136	5154	5172	5190	5208	5226	5244	5262	5280	5298	5316	5334	5352	5370	5388	5406	5424	5442	5460	5478	5496	5514	5532	5550	5568	5586	5604	5622	5640	5658	5676	5694	5712	5730	5748	5766	5784	5802	5820	5838	5856	5874	5892	5910	5928	5946	5964	5982	6000	6018	6036	6054	6072	6090	6108	6126	6144	6162	6180	6198	6216	6234	6252	6270	6288	6306	6324	6342	6360	6378	6396	6414	6432	6450	6468	6486	6504	6522	6540	6558	6576	6594	6612	6630	6648	6666	6684	6702	6720	6738	6756	6774	6792	6810	6828	6846	6864	6882	6900	6918	6936	6954	6972	6990	7008	7026	7044	7062	7080	7098	7116	7134	7152	7170	7188	7206	7224	7242	7260	7278	7296	7314	7332	7350	7368	7386	7404	7422	7440	7458	7476	7494	7512	7530	7548	7566	7584	7602	7620	7638	7656	7674	7692	7710	7728	7746	7764	7782	7800	7818	7836	7854	7872	7890	7908	7926	7944	7962	7980	7998	8016	8034	8052	8070	8088	8106	8124	8142	8160	8178	8196	8214	8232	8250	8268	8286	8304	8322	8340</
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Attorney Docket No.. GEMS-A 0135 PUS (120768)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

the specification of which:

(check one) ☒ [X] is attached hereto
 ☐ [] was filed on herewith; as U.S. Application Serial No. _____; and was amended on _____
(if applicable)
OR PCT International Application Number _____

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 USC §119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International Application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT International Application having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Priority Claimed
Yes No

Certified
Copy Attached
_____ Yes _____ No

<u>(Number)</u>	<u>(Country)</u>	<u>(Day/Month/Year Filed)</u>
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I hereby claim the benefit under 35 USC §120 of any United States application(s), or 365(c) of any PCT International Application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International Application in the manner provided by the first paragraph of 35 USC §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Application(s) OR
PCT Parent Number:

(Serial Number) (Day/Month/Year Filed) (Patented, pending, abandoned)

I hereby claim the benefit under 35 USC § 119(e) of any United States provisional application listed below:

(Application Number) _____ (Day/Month/Year Filed) _____

As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 USC 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor: Gopal B. Avinash
Inventor's signature: [Signature] Date: 10/30/2001
Post Office Address: same as residence Citizenship: INDIA
Residence: 4915 SOUTH RADISSON COURT
NEW BERLIN, WI 53151

FEE TRANSMITTAL

Electronic Version 1.1.0

Stylesheet Version: 1.0

Patent fees are subject to annual revisions on or about October 1st of each year.

Large Entity

TOTAL FEES AUTHORIZED: \$ 780

The commissioner is hereby authorized to charge indicated processing and/or publication fees and credit any overpayments to:

Deposit Account Number: 50-0476



Deposit Account Name: John A. Artz, P.C.

Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.

Charge the Issue Fee Set in 37 C.F.R. Section 1.18 at the Mailing of the Notice of Allowance

SUBMITTED BY

Authorized Name: Kevin G. Mierzwa

Electronic Signature Mark: Kevin G. Mierzwa

Date Signed: 20011101

BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	101	\$ 740

Subtotal For Basic Filing Fee: \$ 740

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 20	103	\$ 18	0	\$ 0
Independent Claims: 3	102	\$ 84	0	\$ 0

Subtotal For Extra Claims Fees: \$ 0

Physical Properties		Chemical Properties		Mechanical Properties		Thermal Properties		Electrical Properties		Optical Properties	
Property	Value	Property	Value	Property	Value	Property	Value	Property	Value	Property	Value
Density	1.25 g/cm ³	Viscosity	0.5 Pa·s	Tensile Strength	10 MPa	Softening Point	150 °C	Volume Resistance	10 ¹² Ω·cm	Refractive Index	1.50
Specific Gravity	1.25	Flow Rate	10 mL/min	Elongation at Break	500%	Thermal Stability	200 °C	Surface Resistance	10 ¹⁰ Ω	Dispersion	0.01
Boiling Point	100 °C	Flash Point	100 °C	Modulus	1 GPa	Decomposition Temp	250 °C	Dielectric Constant	2.5	Absorbance	0.1
Melting Point	0 °C	Autoignition Temp	200 °C	Poisson's Ratio	0.3	Weight Loss (%)	10	Dielectric Loss	0.01	Transmittance	0.9
Crystallinity	50%	Heat of Combustion	40 kJ/mol	Impact Strength	5 kJ/m ²	Char Yield (%)	20	Volume Change (%)	0.1	Color	Colorless
Crystal Size	100 nm	Heat of Formation	10 kJ/mol	Hardness	50 MPa	Residual Stress	10 MPa	Thermal Expansion	10 ppm/°C	Fluorescence	None
Crystal Shape	Spherical	Heat of Polymerization	5 kJ/mol	Compression Modulus	1 GPa	Creep Rate	10 ⁻⁶ %/h	Thermal Contraction	10 ppm/°C	Phosphorescence	None
Crystal Defects	Dislocations	Heat of Crystallization	5 kJ/mol	Shear Modulus	0.5 GPa	Stress Relaxation	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Bioluminescence	None
Crystal Orientation	Random	Heat of Fusion	10 kJ/mol	Bulk Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Diffusivity	10 ⁻⁶ m ² /s	Chemiluminescence	None
Crystal Growth	Isotropic	Heat of Vaporization	40 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Stability	Stable	Heat of Sublimation	80 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Solubility	Insoluble	Heat of Dissolution	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Reactivity	Inert	Heat of Polymerization	5 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Crystallization	5 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biodegradability	Biodegradable	Heat of Fusion	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Vaporization	40 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biodegradability	Biodegradable	Heat of Sublimation	80 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Dissolution	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biodegradability	Biodegradable	Heat of Polymerization	5 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Crystallization	5 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biodegradability	Biodegradable	Heat of Fusion	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Vaporization	40 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biodegradability	Biodegradable	Heat of Sublimation	80 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Dissolution	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
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Crystal Biodegradability	Biodegradable	Heat of Sublimation	80 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/h	Thermal Conductivity	0.1 W/m·K	Photoluminescence	None
Crystal Biocompatibility	Biocompatible	Heat of Dissolution	10 kJ/mol	Dynamic Modulus	1 GPa	Strain Rate Sensitivity	10 ⁻⁶ %/				

Subtotal For Additional Fees: \$ 40